

Amendment and Response

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For: CIRCUIT BOARD SINGULATION METHODS (As Amended)**Abstract of the Disclosure**

Methods to singulate circuit forming regions of a circuit board substrate assembly includes providing a plurality of circuit forming regions including at least one pair of adjacent circuit forming regions separated by at least one opening defined in substrate material between each pair of adjacent circuit forming regions. At least a portion of interconnection regions along singulation axes are removed to singulate the circuit forming regions.